National Semiconductor

June 1998

DS26C32AT/DS26C32AM
Quad Differential Line Receiver

General Description

The DS26C32A is a quad differential line receiver designed to meet the RS-422, RS-423, and Federal Standards 1020 and 1030 for balanced and unbalanced digital data transmission, while retaining the low power characteristics of CMOS.

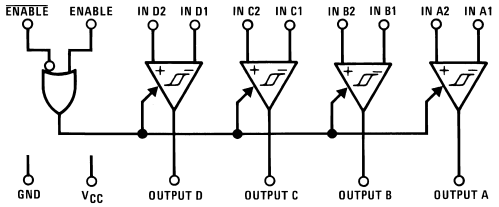
The DS26C32A has an input sensitivity of 200 mV over the common mode input voltage range of ±7V. The DS26C32A features internal pull-up and pull-down resistors which prevent output oscillation on unused channels.

The DS26C32A provides an enable and disable function common to all four receivers, and features TRI-STATE ® outputs with 6 mA source and sink capability. This product is pin compatible with the DS26LS32A and the AM26LS32.

Features

- CMOS design for low power
- ±0.2V sensitivity over input common mode voltage range
- Typical propagation delays: 19 ns
- Typical input hysteresis: 60 mV
- Inputs won't load line when V_{CC} = 0V
- Meets the requirements of EIA standard RS-422
- TRI-STATE outputs for connection to system buses
- Available in Surface Mount
- Mil-Std-883C compliant

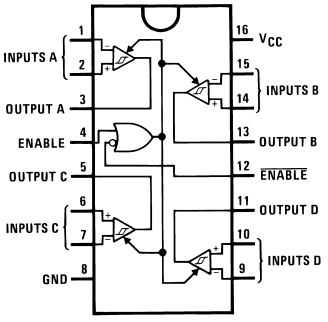
Logic Diagram



00876401

Connection Diagrams

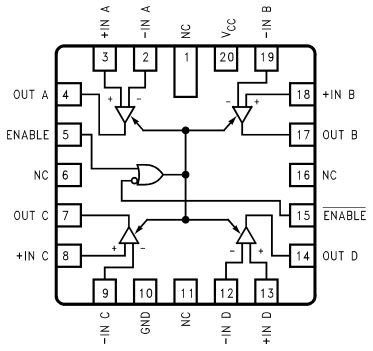
Dual-In-Line Package



00876402

Top View
Order Number DS26C32ATM or DS26C32ATN
See NS Package M16A or N16E
For Complete Military Product Specifications, refer to the appropriate SMD or MDS.
Order Number DS26C32AME/883, DS26C32AMJ/883 or DS26C32AMW/883
See NS Package E20A, J16A or W16A

20-Lead Ceramic Leadless Chip Carrier



00876412

TRI-STATE® is a registered trademark of National Semiconductor Corporation.

© 2004 National Semiconductor Corporation

Absolute Maximum Ratings (Notes 2, 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (V_{CC})	7V
Common Mode Range (V_{CM})	±14V
Differential Input Voltage (V_{DIFF})	±14V
Enable Input Voltage (V_{IN})	7V
Storage Temperature Range (T_{STG})	−65˚C to +150˚C
Lead Temperature (Soldering 4 sec.)	260˚C
Maximum Power Dissipation at 25˚C (Note 5)	
Ceramic "J" Pkg.	2308 mW
Plastic "N" Pkg.	1645 mW
SOIC "M" Pkg.	1190 mW
Ceramic "E" Pkg.	2108 mW
Ceramic "W" Pkg.	1215 mW
Maximum Current Per Output	±25 mA

This device does not meet 2000V ESD rating. (Note 4)

Operating Conditions

	Min	Max	Units
Supply Voltage (V_{CC})	4.50	5.50	V
Operating Temperature Range (T_A)			
DS26C32AT	−40	+85	˚C
DS26C32AM	−55	+125	˚C
Enable Input Rise or Fall Times		500	ns

DC Electrical Characteristics

V_{CC} = 5V ±10% (unless otherwise specified) (Note 1)

Symbol	Parameter	Conditions		Min	Typ	Max	Units
V_{TH}	Minimum Differential Input Voltage	$V_{OUT} = V_{OH}$ or V_{OL} $-7V < V_{CM} < +7V$		−200	35	+200	mV
R_{IN}	Input Resistance	V_{IN} = −7V, +7V (Other Input = GND)	DS26C32AT	5.0	6.8	10	kΩ
			DS26C32AM	4.5	6.8	11	kΩ
I_{IN}	Input Current	V_{IN} = +10V, Other Input = GND	DS26C32AT		+1.1	+1.5	mA
			DS26C32AM		+1.1	+1.8	mA
		V_{IN} = −10V, Other Input = GND	DS26C32AT		−2.0	−2.5	mA
			DS26C32AM		−2.0	−2.7	mA
V_{OH}	Minimum High Level Output Voltage	V_{CC} = Min, V_{DIFF} = +1V I_{OUT} = −6.0 mA		3.8	4.2		V
V_{OL}	Maximum Low Level Output Voltage	V_{CC} = Max, V_{DIFF} = −1V I_{OUT} = 6.0 mA			0.2	0.3	V
V_{IH}	Minimum Enable High Input Level Voltage			2.0			V
V_{IL}	Maximum Enable Low Input Level Voltage					0.8	V
I_{OZ}	Maximum TRI-STATE® Output Leakage Current	$V_{OUT} = V_{CC}$ or GND, ENABLE = V_{IL}, $\overline{\text{ENABLE}} = V_{IH}$			±0.5	±5.0	µA
I_I	Maximum Enable Input Current	$V_{IN} = V_{CC}$ or GND				±1.0	µA
I_{CC}	Quiescent Power Supply Current	V_{CC} = Max, V_{DIF} = +1V	DS26C32AT		16	23	mA
			DS26C32AM		16	25	mA
V_{HYST}	Input Hysteresis	V_{CM} = 0V			60		mV

AC Electrical Characteristics

V_{CC} = 5V ±10% (Note 3)

Symbol	Parameter	Conditions	Min	Typ	Max		Units
					DS26C32AT	DS26C32AM	
t_{PLH}, t_{PHL}	Propagation Delay Input to Output	C_L = 50 pF V_{DIFF} = 2.5V V_{CM} = 0V	10	19	30	35	ns

AC Electrical Characteristics (Continued)

V_{CC} = 5V ±10% (Note 3)

Symbol	Parameter	Conditions	Min	Typ	Max		Units
					DS26C32AT	DS26C32AM	
t_{RISE}, t_{FALL}	Output Rise and Fall Times	C_L = 50 pF, V_{DIFF} = 2.5V, V_{CM} = 0V		4	9	9	ns
t_{PLZ}, t_{PHZ}	Propagation Delay ENABLE to Output	C_L = 50 pF, R_L = 1000Ω, V_{DIFF} = 2.5V		13	22	29	ns
t_{PZL}, t_{PZH}	Propagation Delay ENABLE to Output	C_L = 50 pF, R_L = 1000Ω, V_{DIFF} = 2.5V		13	23	29	ns

Note 1: Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 2: Unless otherwise specified, all voltages are referenced to ground.

Note 3: Unless otherwise specified, Min/Max limits apply over recommended operating conditions. All typicals are given for V_{CC} = 5V and T_A = 25˚C.

Note 4: ESD Rating: HBM (1.5 kΩ, 100 pF)

Inputs ≥2000V

All other pins ≥1000V

EIAJ (0Ω, 200 pF) ≥350V

Note 5: Ratings apply to ambient temperature at 25˚C. Above this temperature derate N Package 13.16 mW/˚C, J Package 15.38 mW/˚C, M Package 9.52 mW/˚C, E Package 12.04 mW/˚C, and W package 6.94 mW/˚C.

Comparison Table of Switching Characteristics into "LS-Type" Load

(*Figures 4, 5, 6*) (Note 6)

Symbol	Parameter	Conditions	DS26C32A	DS26LS32A	Units
			Typ	Typ	
t_{PLH}	Input to Output	C_L = 15 pF	17	23	ns
t_{PHL}			19	23	ns
t_{LZ}	ENABLE to Output	C_L = 5 pF	13	15	ns
t_{HZ}			12	20	ns
t_{ZL}	ENABLE to Output	C_L = 15 pF	13	14	ns
t_{ZH}			13	15	ns

Note 6: This table is provided for comparison purposes only. The values in this table for the DS26C32A reflect the performance of the device, but are not tested or guaranteed.

Test and Switching Waveforms

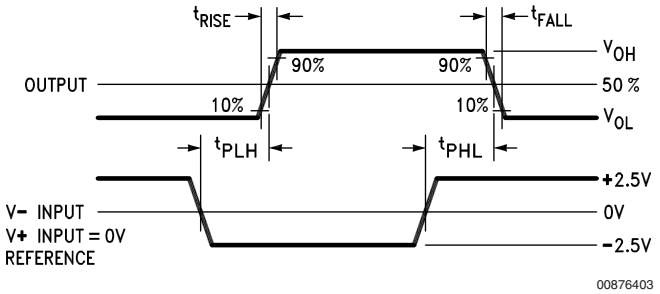
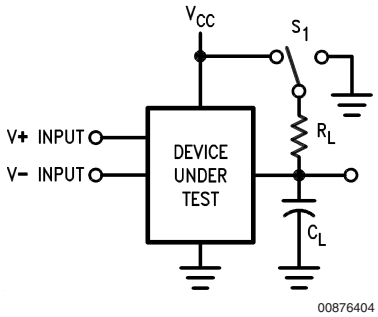


FIGURE 1. Propagation Delay

Test and Switching Waveforms (Continued)



C_L includes load and test jig capacitance.
$S_1 = V_{CC}$ for t_{PZL}, and t_{PLZ} measurements.
S_1 = Gnd for t_{PZH} and t_{PHZ} measurements.

FIGURE 2. Test Circuit for TRI-STATE Output Tests

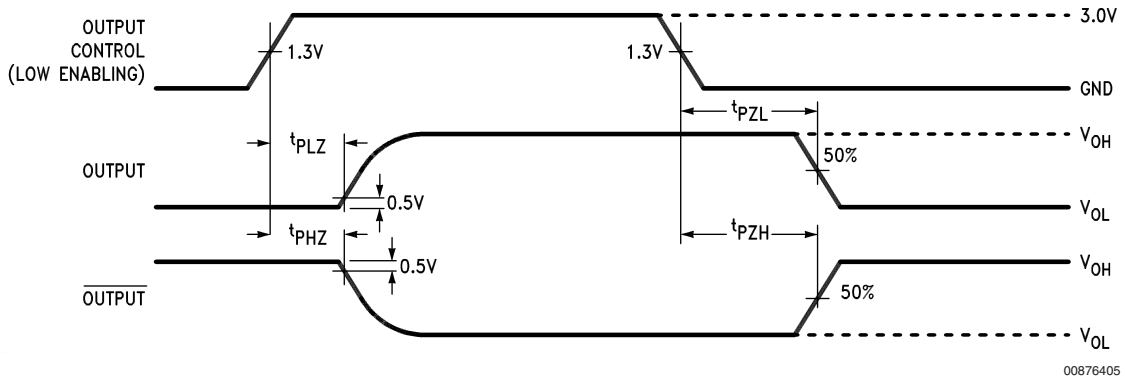


FIGURE 3. TRI-STATE® Output Enable and Disable Waveforms

AC Test Circuit and Switching Time Waveforms

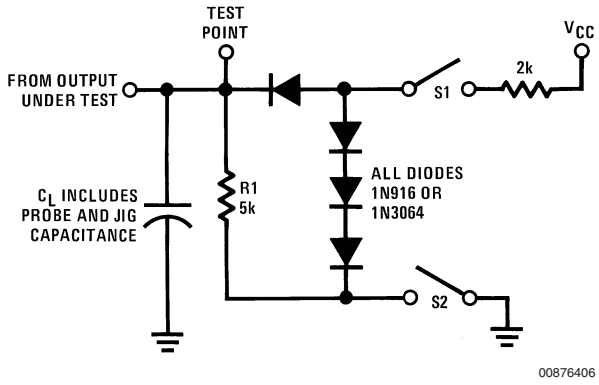


FIGURE 4. Load Test Circuit for TRI-STATE Outputs for "LS-Type" Load

AC Test Circuit and Switching Time Waveforms (Continued)

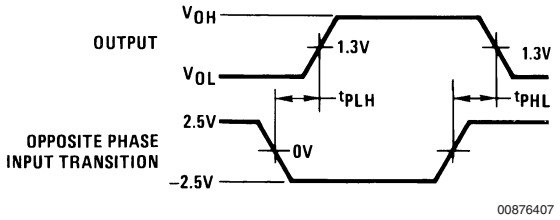


FIGURE 5. Propagation Delay for "LS-Type" Load (Notes 7, 9)

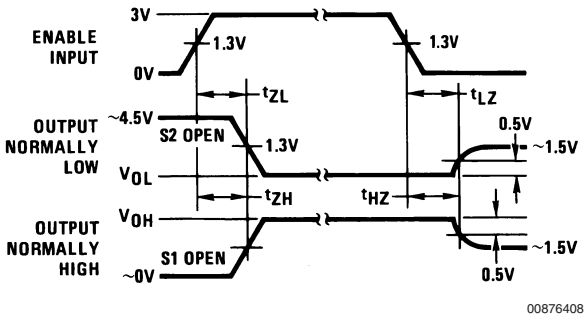


FIGURE 6. Enable and Disable Times for "LS-Type" Load (Notes 8, 9)

Note 7: Diagram shown for $\overline{\text{ENABLE}}$ low.

Note 8: S1 and S2 of load circuit are closed except where shown.

Note 9: Pulse generator for all pulses: Rate ≤ 1.0 MHz; $Z_O = 50\Omega$; $t_r \leq 15$ ns; $t_f \leq 6.0$ ns.

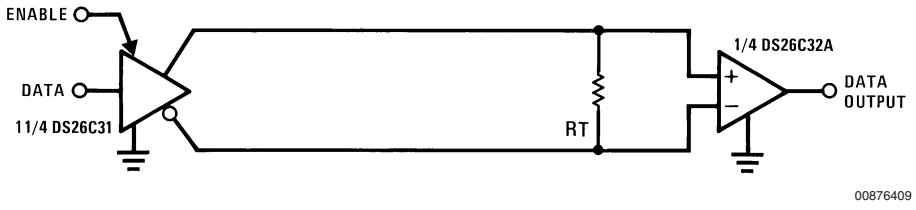
Truth Table

ENABLE	$\overline{\text{ENABLE}}$	Input	Output
L	H	X	Z
All Other Combinations of Enable Inputs		$V_{ID} \geq V_{TH}$ (Max)	H
		$V_{ID} \leq V_{TH}$ (Min)	L
		Open	H

Z = TRI-STATE

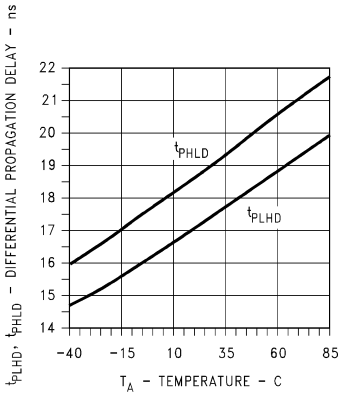
Typical Applications

Two-Wire Balanced Systems, RS-422



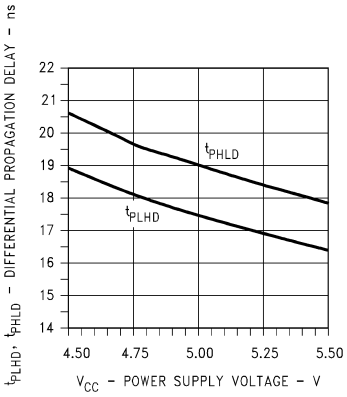
Typical Performance Characteristics

Differential Propagation Delay vs Temperature



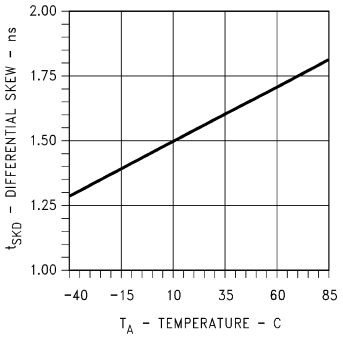
00876413

Differential Propagation Delay vs Power Supply Voltage



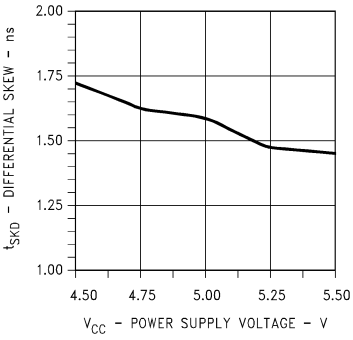
00876414

Differential Skew vs Temperature



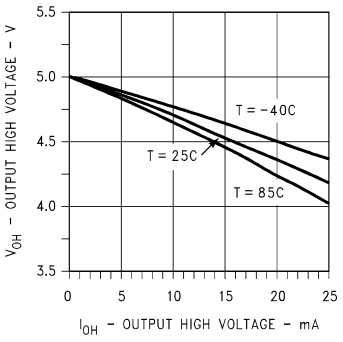
00876415

Differential Skew vs Power Supply Voltage



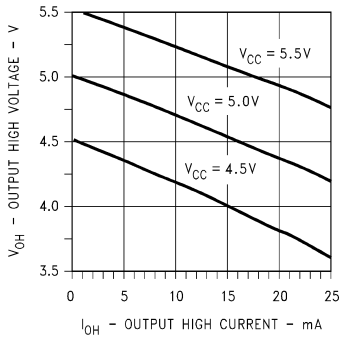
00876416

Output High Voltage vs Output High Current



00876417

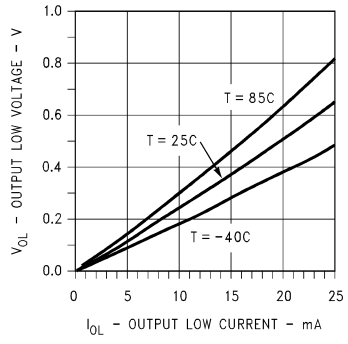
Output High Voltage vs Output High Current



00876418

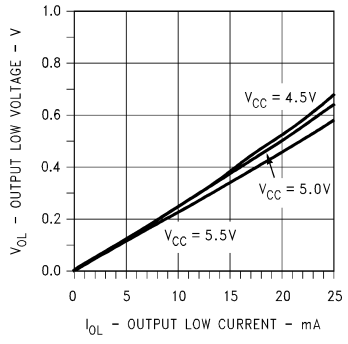
Typical Performance Characteristics (Continued)

Output Low Voltage vs Output Low Current



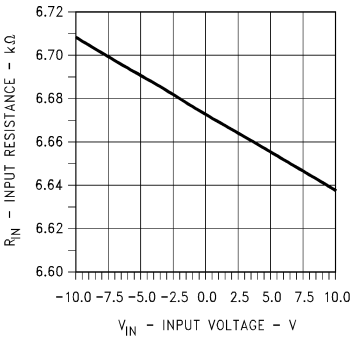
00876419

Output Low Voltage vs Output Low Current



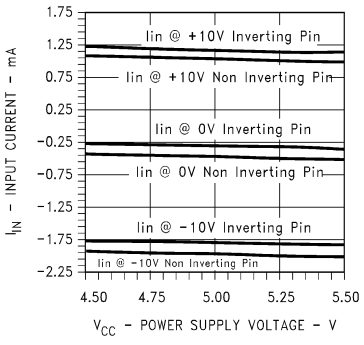
00876420

Input Resistance vs Input Voltage



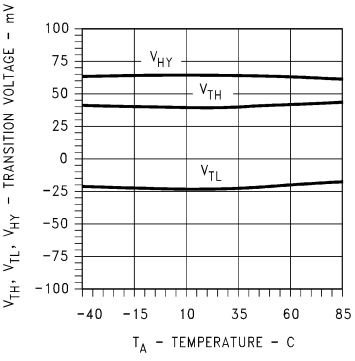
00876421

Input Current vs Power Supply Voltage



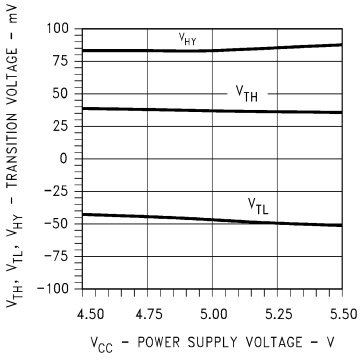
00876422

Hysteresis & Differential Transition Voltage vs Temperature



00876423

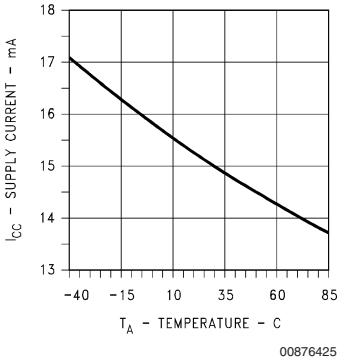
Hysteresis & Differential Transition Voltage vs Power Supply Voltage



00876424

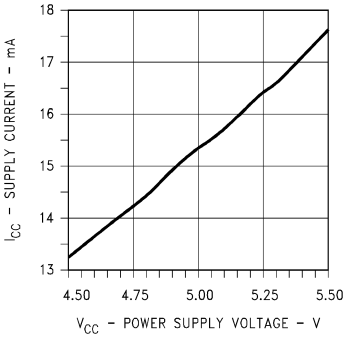
Typical Performance Characteristics (Continued)

Supply Current vs Temperature



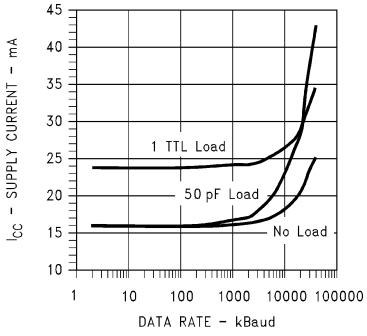
00876425

Disabled Supply Current vs Power Supply Voltage



00876426

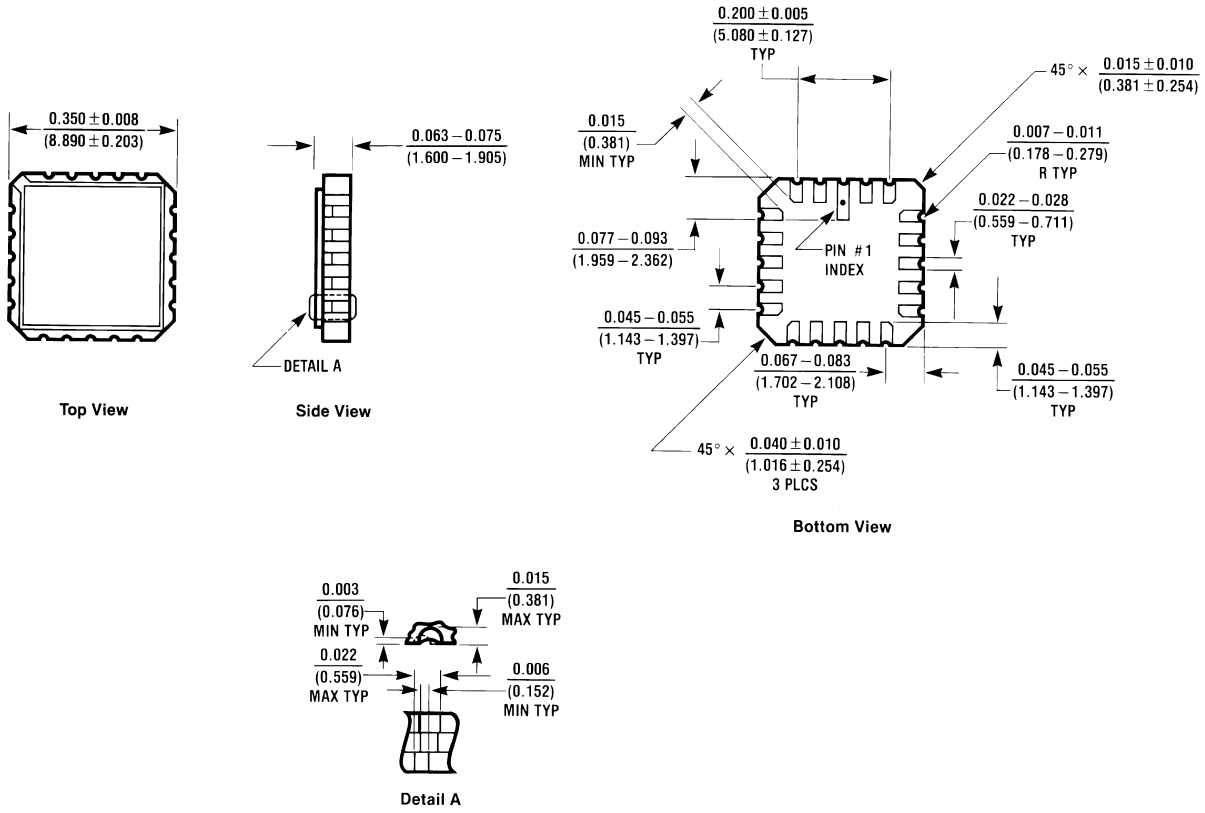
Supply Current vs Data Rate



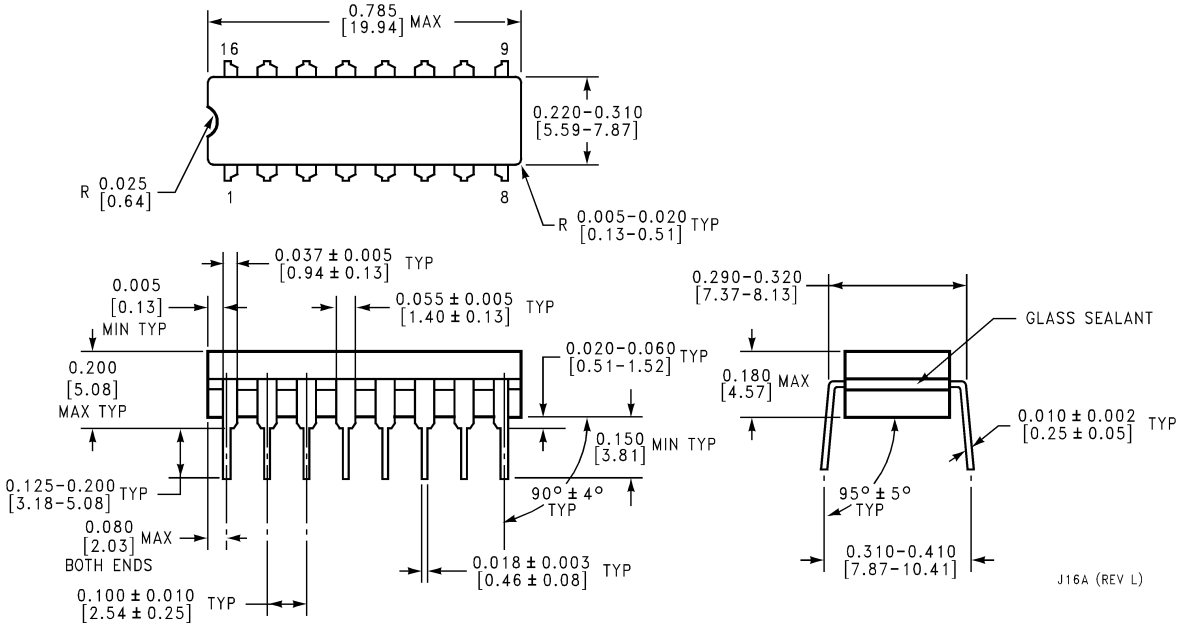
00876427

Physical Dimensions inches (millimeters)

unless otherwise noted

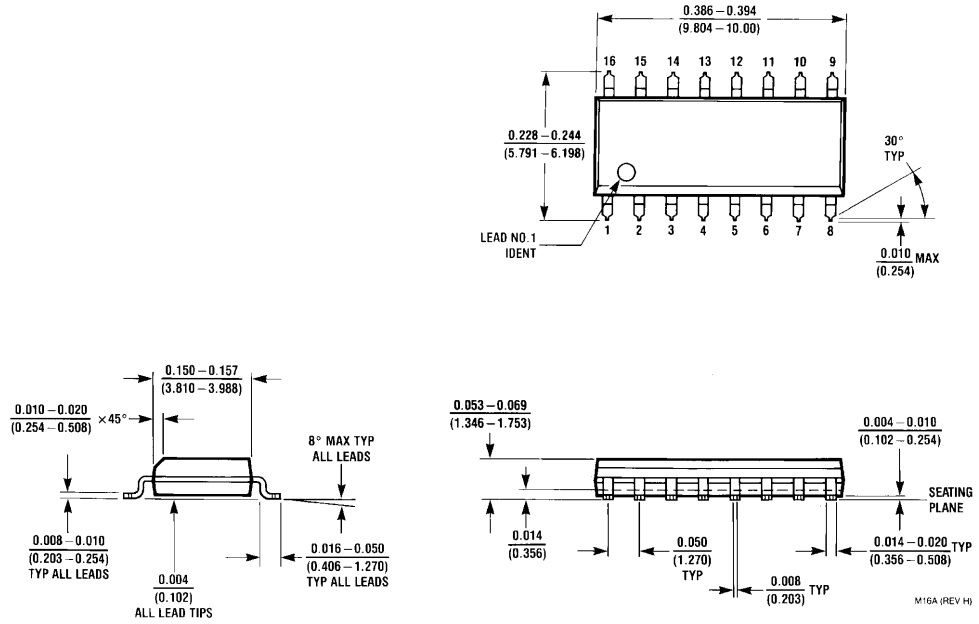


20-Lead Ceramic Leadless Chip Carrier (E)
Order Number DS26C32AME/883
NS Package Number E20A

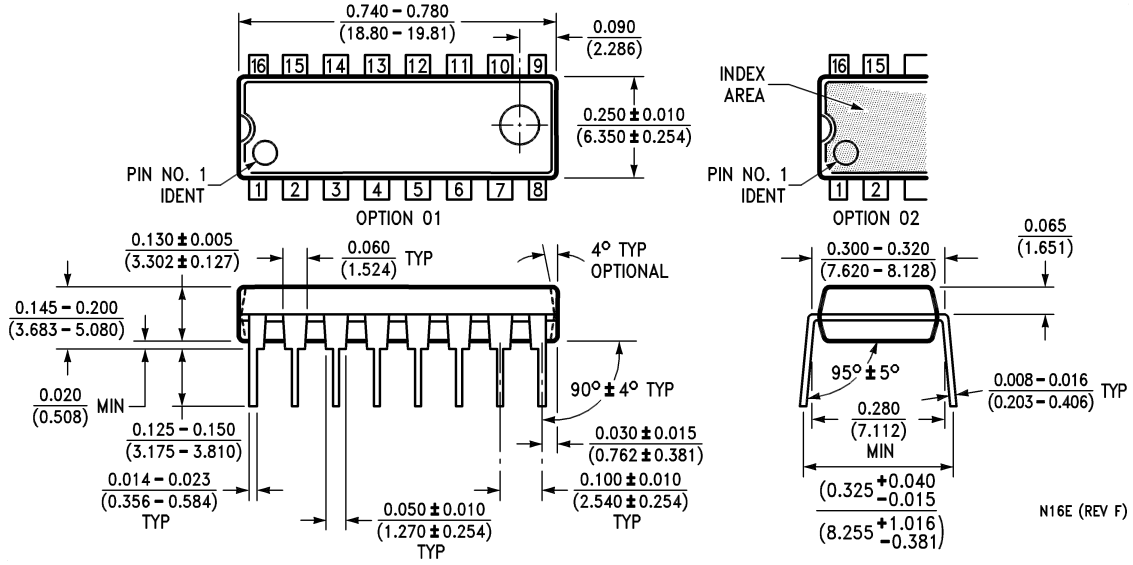


16-Lead Ceramic Dual-In-Line Package (J)
Order Number DS26C32AMJ/883
NS Package Number J16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

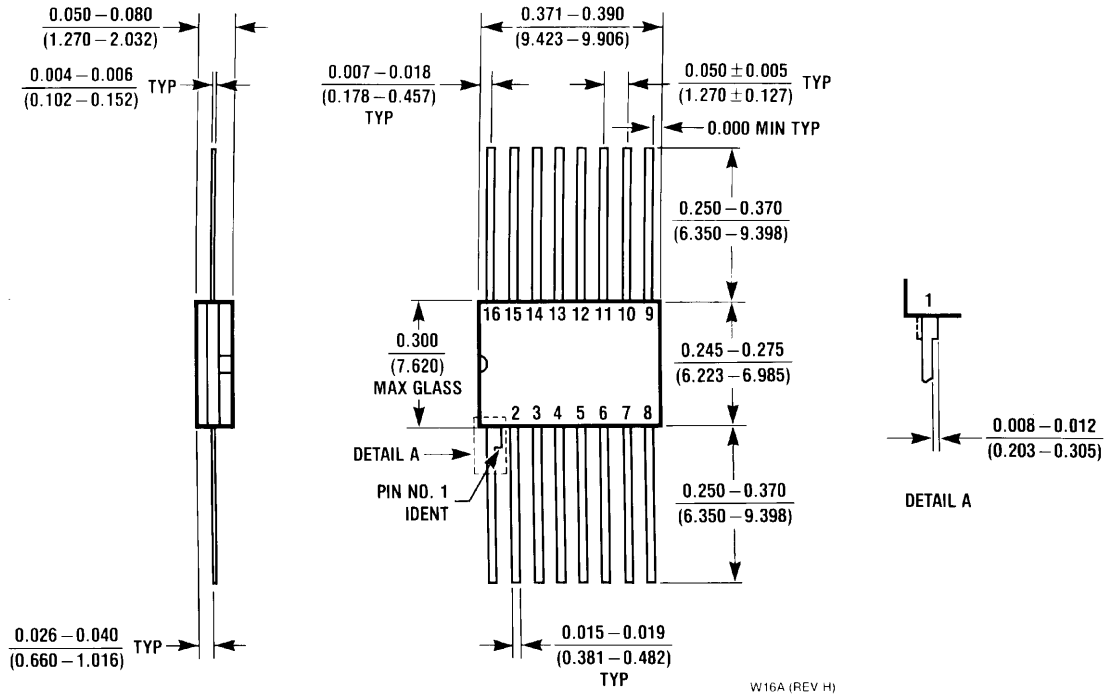


16-Lead Molded Small Outline Package (M)
Order Number DS26C32ATM
NS Package Number M16A



16-Lead Molded Dual-In-Line Package (N)
Order Number DS26C32ATN
NS Package Number N16E

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Ceramic FlatPak (W)
Order Number DS26C32AMW/883
NS Package Number W16A

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

BANNED SUBSTANCE COMPLIANCE

National Semiconductor certifies that the products and packing materials meet the provisions of the Customer Products Stewardship Specification (CSP-9-111C2) and the Banned Substances and Materials of Interest Specification (CSP-9-111S2) and contain no "Banned Substances" as defined in CSP-9-111S2.

National Semiconductor
Americas Customer
Support Center
Email: new.feedback@nsc.com
Tel: 1-800-272-9959

www.national.com

National Semiconductor
Europe Customer Support Center
Fax: +49 (0) 180-530 85 86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 69 9508 6208
English Tel: +44 (0) 870 24 0 2171
Français Tel: +33 (0) 1 41 91 8790

National Semiconductor
Asia Pacific Customer
Support Center
Email: ap.support@nsc.com

National Semiconductor
Japan Customer Support Center
Fax: 81-3-5639-7507
Email: jpn.feedback@nsc.com
Tel: 81-3-5639-7560

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.